OIPE CE

Docket No. AMENDMENT TRANSMITTAL LETTER 8733.170.10-US Examiner Art Unit Application No. Filing Date 10/671,552-Conf. #4274 September 29, 2003 A. G. Ghyka 2812 Applicant(s): Kwang Nam Kim et al. METHOD OF FORMING SILICON OXIDE LAYER AND METHOD OF MANUFACTURING Invention: THIN FILM TRANSISTOR THEREBY TO THE COMMISSIONER FOR PATENTS Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below. CLAIMS AS AMENDED Claims Highest Remaining Number Number Previously **Extra Claims** After **Amendment** Present Rate Paid 0.00 **Total Claims** 20 10 Х Independent = 1 3 0.00 Х Claims Multiple Dependent Claims (check if applicable) Other fee (please specify): TOTAL ADDITIONAL FEE FOR THIS AMENDMENT: 0.00 x | Large Entity Small Entity x No additional fee is required for this amendment. Please charge Deposit Account No. in the amount of \$ A duplicate copy of this sheet is enclosed. A check in the amount of \$ to cover the filing fee is enclosed. Payment by credit card. Form PTO-2038 is attached. 50-0911 X The Director is hereby authorized to charge and credit Deposit Account No. as described below. A duplicate copy of this sheet is enclosed. x | Credit any overpayment. Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17. Dated: July 9, 2004 Repecca Goldman Rudich Attorney Reg. No.: 41,786 MCKENNA LONG & ALDRIDGE LLP 1900 K Street, N.W. Washington, DC 20006 (202) 496-7463



Docket No.: 8733.170.10-US

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Kwang Nam KIM, et al.

Confirmation No. 4274

Application No.: 10/671,552

Art Unit: 2812

Filed: September 29, 2003

Examiner: Ghyka, Alexander G.

For: METHOD OF FORMING SILICON OXIDE

Customer No. 30827

LAYER AND METHOD OF MANUFACTURING THIN FILM

TRANSISTOR THEREBY

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated April 9, 2004 (Paper No. 0331), please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. This listing of claims replaces all prior versions and listings of claims in the application.

Remarks/Arguments begin on page 4 of this paper.